

Facts & figures

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Company profile:	Leading provider for development, production and marketing of special machines for the semiconductor industry with an internationally unique product portfolio for handling thin silicon wafers
Company headquarters:	mechatronic systemtechnik gmbh Tiroler Straße 80 A-9500 Villach Tel.: +43-(0)4242-33999-0 Internet: www.mechatronic.at
History:	1998 Establishment of the company, 2001 Commissioning of the cleanroom, 2004 Redevelopment of an internationally unique thin-wafer handling machine; 2005/6 Start of series production of thin-wafer handling systems, 2008-10 large scale and worldwide roll-out of the thin-wafer handling machines
Shareowners:	Walter Schober (CEO), Danube Equity, FIDURA Private Equity Funds and Andreas Lummerstorfer (private investor).
Management board:	Walter Schober (CEO), Alexander Oremus (CTO), Martina Linter (CFO)
Employees:	50
Subsidiaries/ branches:	None
Products and services:	Thin-wafer handling systems and components for contact-less handling of wafers with sizes of 150, 200 or 300 millimetres and a thickness of 50 to 150 micrometres Cleanroom engineering & assembly – Assembly of process machines for the semiconductor industry in a cleanroom of class 1,000 / US FED Standard 209 Manufacturing – Mechanical and plastic production of simple workpieces and complex system components from various materials
Sales & marketing:	Europe: Direct by Mechatronic Systemtechnik, USA / Asia: Via sales partners
Customers:	Infineon, NXP, Nikon, ASE, STATS ChipPAC